

SPECIFICATIONS

Mechanical

Contact Retention Force: 0.50Kg min. per contact Durability: 50 Cycles Insertion Force(Conn. Into PCB): 0.117Kg max. Unmating Force(Per Contact pair): 0.154Kg min.

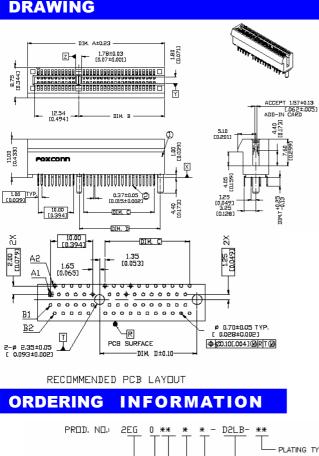
Electrical

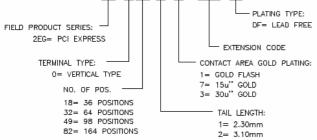
Current Rating: 1.1 Amps per pin max. Insulation Resistance: 1000MΩ min. at 500V DC Dielectric Withstanding Voltage: Apply 500VAC for 1 minute between adjacent terminals of an unmated connector. No breakdown. Low Level Contact Resistance: $30m\Omega$ max. initial, Change not greater than $20m\Omega$ Max.

Physical

Housing: Thermoplastic, UL 94V-0 rated in White Color Contact: Copper alloy **Operating Temperature:** -40 $^{\circ}$ C to +105 $^{\circ}$

DRAWING

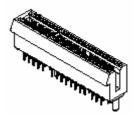




	2EG082**-D2LB-DF	8	9.00	74.15		70.00	73.15	
-	2EG049**-D2LB-DF	56.00		41.50		37.00	40.15	
	2EG032**-D2LB-DF	39.00		24.50		20.00	23.15	
	2EG018**-D2LB-DF	25.00		10.50		6.00	9.15	
	PRODUCT NUMBER	DI	M. A	DIM. B		DIM. C	DIM. D	
	2EG0**2*-D2LB-DF 2EG0**1*-D2LB-DF PRODUCT NUMBER		3.10				·	
			2.30					
			DIM. T		Ì			

PCI-E Connector

2EG0 Series T/H Type 1.00mm [.039"] Pitch 64 Pos.



All specification & dimensions are subject to change, please call your nearest Foxconn sales representative for update information.